



80V 175°C DUAL N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on) Max	I _D Max T _C = +25°C
80V	$26m\Omega$ @ $V_{GS} = 10V$	28.5A
	45mΩ @ V _{GS} = 4.5V	21A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- DC-DC converters
- Motors

Features and Benefits

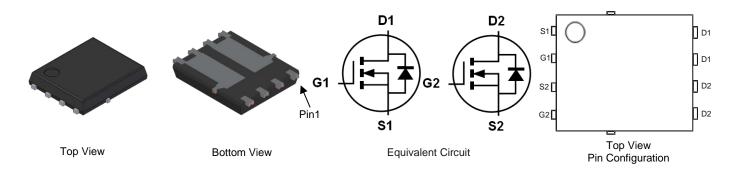
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production –
 Ensures More Reliable and Robust End Application
- Low Input Capacitance
- Fast Switching Speed
- Wettable Flank for Improved Optical Inspection
- Additional Tin-Plated on Sidewall Pads for Optical Solder Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH8030LPDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

PowerDI5060-8/SWP (Type UXD)



Ordering Information (Note 4)

Part Number	Packago	Packing		
Fait Number	Package	Qty.	Carrier	
DMTH8030LPDWQ-13	PowerDI5060-8/SWP (Type UXD)	2500	Tape & Reel	

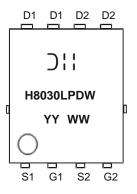
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

PowerDI is a registered trademark of Diodes Incorporated.



Marking Information



⊃¦¦= Manufacturer's Marking H8030LPDW = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 22 = 2022) WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	80	V	
Gate-Source Voltage	Vgss	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 6) $T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$		lo	28.5 20	А
Maximum Body Diode Forward Current	Is	29	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	113.5	А	
Pulsed Body Diode Forward Current (10µs Pulse, Tc = +25°C, Package	Ism	113.5	A	
Avalanche Current, L = 0.3mH	las	12.5	A	
Avalanche Energy, L = 0.3mH	Eas	23.4	mJ	

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	48	°C/W	
Total Power Dissipation $T_A = +25^{\circ}C$		PD	3.1	W
Thermal Resistance, Junction to Case (Note 6)	Rejc	3.7	°C/W	
Total Power Dissipation	T _C = +25°C	PD	41	W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +175	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- 6. Thermal resistance from junction to solder point (on the exposed drain pin).



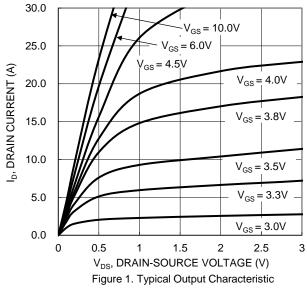
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	80	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	V _{DS} = 64V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(TH)	1.3	_	2.5	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D		20	26	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	29	45	11122	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	VsD	_	0.9	1.2	V	Vgs = 0V, Is = 10A	
DYNAMIC CHARACTERISTICS (Note 8)	DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	1	631	_		V _{DS} = 40V, V _{GS} = 0V, f = 1.0MHz	
Output Capacitance	Coss	_	200	_	pF		
Reverse Transfer Capacitance	Crss	_	19.5	_			
Gate Resistance	Rg	_	1.1	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	5.4	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	10.4	_	nC	V _{DS} = 40V, I _D = 7.5A	
Gate-Source Charge	Qgs	_	1.8	_	110		
Gate-Drain Charge	Q_{gd}	_	2.4	_			
Turn-On Delay Time	t _{D(ON)}	_	7.1	_		V _{DD} = 40V, V _{GS} = 4.5V, R _G = 2.7Ω, I _D = 10A	
Turn-On Rise Time	t _R	_	9.7	_	no		
Turn-Off Delay Time	tD(OFF)	_	18.6	_	ns		
Turn-Off Fall Time	tF	_	8.6	_			
Body Diode Reverse Recovery Time	t _{RR}	_	28.5	_	ns	I _F = 7.5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Qrr		21.7	_	nC	I _F = 7.5A, di/dt = 100A/μs	

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.





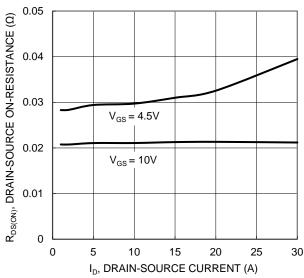


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

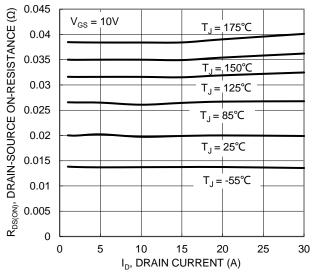
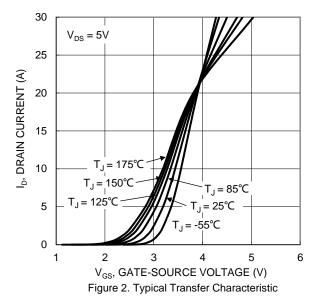
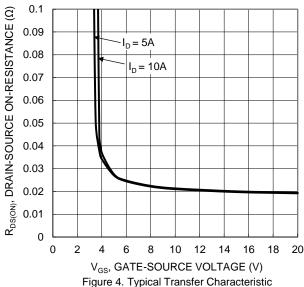


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





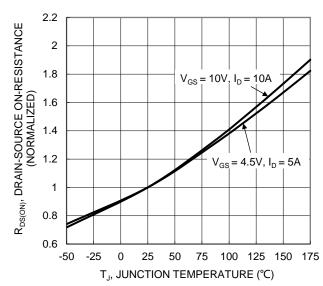


Figure 6. On-Resistance Variation with Junction Temperature



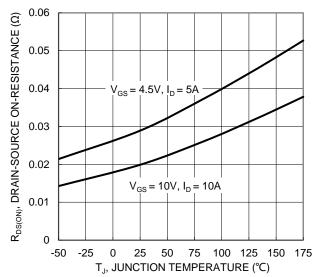
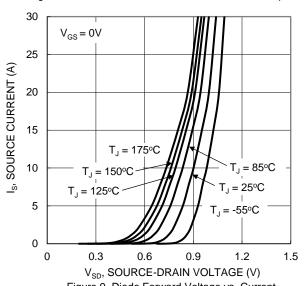
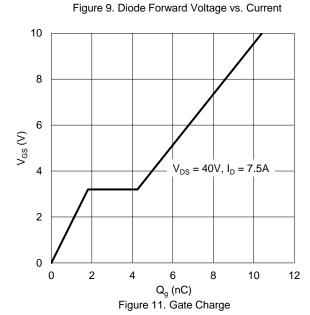


Figure 7. On-Resistance Variation with Junction Temperature





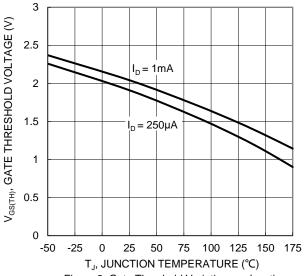
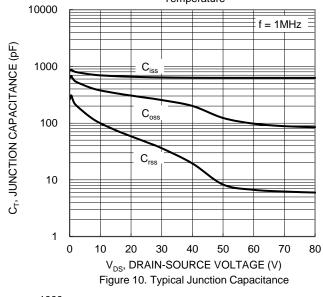


Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 R_{DS(ON)} Limited 100 ID, DRAIN CURRENT (A) 10 $T_{J(Max)} = 175$ °C T_C = 25°C Single Pulse DUT on Infinite Heatsink $V_{GS} = 10V$ 0.01 0.1 1 10 100 V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



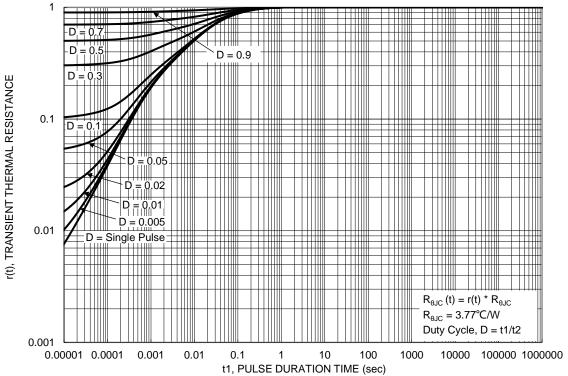


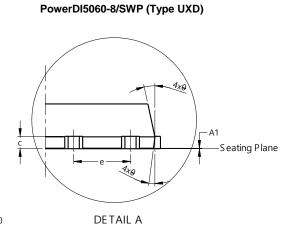
Figure 13. Transient Thermal Resistance

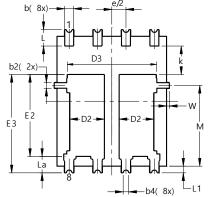


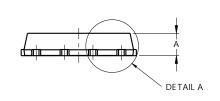
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

01.000 Depth 0.07±0.030





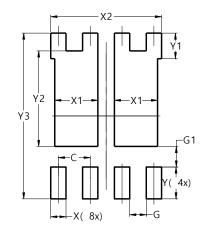


PowerDI5060-8/SWP					
(Type UXD)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF			
C	0.230	0.330	0.277		
D	5	.15 BS0			
D1	4.70	5.10	4.90		
D2	1.46	1.66	1.55		
D3	3.78	4.18	3.98		
Е	6	.40 BS0			
E1	5.60	6.00	5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
M	3.205	4.005	3.605		
W	0.025	0.225	0.125		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UXD)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
Х	0.610		
X1	1.720		
X2	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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